Update of EUV Source Development Status for HVM Lithography

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Carbon-dioxide laser driven, Sn-fueled, laser-produced-plasma (LPP) extreme UV (EUV) source emitting at 13.5 nm wavelength is currently regarded as a most promising route to EUV power levels required by high-volume-manufacturing (HVM) EUV lithography. We at Gigaphoton have been developing the CO₂-Sn-LPP EUV light source since 2003. Along the way a range of unique, original technologies has been developed, such as a combination of ns-pulse CO₂ laser and Sn droplets, dual-wavelength laser target pre-conditioning for an increased CO₂-to-EUV conversion efficiency (CE) and a plasma debris mitigation using a magnetic field, to name a few of them. The theoretical and experimental data accumulated so far have clearly showed the advantage of our proposed strategy. We report engineering data obtained from our prototype system #2, such as 43W average, clean EUV power at 100 kHz pulse repetition rate. Also, high CE value of 3.9% was demonstrated at 20 kHz repetition rate. Based on these achievements we are developing our first production source for HVM codenamed “GL200E”. We project to reach EUV power level of 250W from currently available CO₂ laser power of about 20kW. The development works aiming at higher CO₂ laser (and EUV) power are currently in progress in cooperation with Mitsubishi Electric.

Keywords: LPP, EUV, light source, lithography, semiconductor, 13.5 nm, HVM

1. Introduction

Extreme ultraviolet (EUV) light source and wafer exposure tool technologies are being developed concurrently. In 2007 ASML has shipped its first “α-demo tool” and Nikon shipped its own EUV-1 system in 2008, both equipped with an early 10W EUV source. In the beginning of 2011 ASML has shipped the “β-tool”, NXE-3100 employing 100W EUV light source. Since 2003 we have been developing the carbon dioxide (CO₂) laser produced tin (Sn) plasma (CO₂-Sn-LPP) EUV light source of 13.5 nm wavelength, which is considered as the most promising solution to produce high power (>200 W) light source required by HVM EUV lithography (EUVL). We have chosen the CO₂-Sn-LPP-EUV variant because of its relatively high efficiency, power scalability, and spatial freedom it provides around the plasma location. The theoretical and experimental data have clearly demonstrated that the combination of CO₂ laser and Sn plasma can realize high conversion efficiency (CE) into 13.6 nm EUV light contained essentially within 2% bandwidth.

We have demonstrated in the past, using our 2Hz R&D EUV system, the advantage of CO₂ laser as a plasma driver in terms of high CE values >4.7%. We have made efforts to incorporate these R&D results into a HVM-worthy prototype operating at 100kHz pulse repetition rate. Several technical challenges were faced, such as a sufficiently stable operation of a droplet generator, a stability of the CO₂ laser beam at high average power, and a sufficiently accurate control of target irradiation conditions. In the present paper we provide an update of our latest progress in these areas.

2. LPP EUV light source system

2.1 System concept

Fig. 1 Concept of Gigaphoton’s HVM EUV light source.

The concept of Gigaphoton’s HVM EUV light source is shown schematically in Fig. 1. The concept is characterized by 5 key, patent-pending technologies:

(1) High ionization rate and high CE achieved by a combined CO₂ and solid-state laser irradiation of the Sn target.
(2) Original, hybrid CO₂ laser system featuring a high repetition rate, solid-state seeded, short 20ns pulse oscillator, amplified by a system of commercial, multi-kW cw-amplifiers.
(3) Accurate control of target irradiation conditions.
(4) Mitigation of Sn debris with a super-conductive magnet.
(5) Highly-efficient filtration of out-of-band radiation using a grating structured EUV collector mirror.

Fig. 2 Concept of EUV emission & Sn mitigation processes

The concept of Sn debris mitigation with a magnetic field is shown in Fig. 2. At first, the tin droplet is irradiated with the pre-pulse laser and is rapidly converted from a high-density liquid into a lower-density mist of sub-micron sized, liquid particles. Next, after a certain time delay, the mist cloud is irradiated by a pulsed CO₂ laser beam and turned into a high-temperature plasma, where the Sn ions undergo a multiple-order ionization and the plasma emits (among other wavelengths) 13.5 nm EUV light during recombination processes. The residues of the plasma, which remain after the EUV emission is finished, are eventually scattered inside the vessel if no precautions are taken. In order to prevent the collector mirror from being contaminated, Sn plasma (and its products) has to be constrained spatially. Thanks to a high degree of ionization, most of the Sn ions can be trapped by the magnetic field in the trajectories of so-called Larmor movements. To enhance EUV energy and to maximize Sn debris mitigation, the number of Sn ions should be maximized in these laser heating processes.

2.2 Pre-pulse technology

2.2.1 Case of ns pre-pulse

We have found that the initial droplet becomes highly fragmented after the pre-pulse irradiation. By volume, the fragments constitute a major part of the preconditioned Sn target. The diameter of the fragments can reach as much as a few micrometers, as evidenced by a stroboscopic, shadowgraph metrology utilizing a few-nanosecond, pulsed back illuminator and a CCD camera equipped with a high-resolution telescope.

Fig. 3 shows the shadowgraphs of the fragments after the pre-pulse laser irradiation of the 20μm droplet, which was irradiated by the pre-pulse laser arriving from the left hand side in the image. After the laser irradiation, the cloud of fragments expanded in diameter while travelling in a direction being a vector sum of initial droplet momentum and a net momentum increase resulting from the laser irradiation. Fig. 3(a) shows a case where (we believe) the vaporization of Sn fragments upon CO₂ laser irradiation was seen to be nearly complete. In contrast, Fig. 3(b) below shows shadowgraphs obtained in a situation of non-optimal cloud condition, which resulted in easily observable fragment residues.

The experiments have shown that some optimal conditions exist for a near-perfect vaporization and ionization of Sn fragments and that they can be obtained by an appropriate selection of irradiation conditions, such as pre-pulse/main-pulse combination and a sufficiently small droplet diameter. We have therefore investigated the conversion efficiency (CE) as a function of the droplet diameter and the pre-pulse laser irradiation. Fig. 4 shows the results indicating that high CE can be obtained even with a droplet size below 20μm. The pre-pulse laser irradiation was seen to be a key requirement for obtaining higher CE. The CE reached 3.3 % with the 20μm in diameter droplet following the optimization of the pre-pulse laser conditions. We have thus found a way to reduce the debris without the degradation of CE by using droplets of diameter <20μm and a proper combination of target irradiation conditions.
2.2.2 Case of ps pre-pulse

High CE of 4.7 % has been demonstrated in our R&D setup, as shown in Fig.5 (red upper line), following an implementation of ps-pulse target preconditioning of 20μm droplets. These basic studies, supporting the accompanying theoretical considerations, have contributed to the development of the high-power production system and to the basic design for further EUV power scaling.

The significant increase of CE, following a picosecond pre-pulse, is explainable by a difference of mist formation and expansion mechanisms associated with the nanosecond and picosecond timescales. This high CE technology enables 250W EUV source from a moderate 20kW CO₂ laser power.

The relative proportion of ions and neutrals, or the ionization ratio, is an important parameter in the process of low-debris, high-CE EUV emission. A spectroscopic, laser-induced-fluorescence (LIF) method was employed to directly measure the ionization ratio. The LIF imaging of the Sn atoms has several advantages, such as a selectivity of species and high sensitivity. A schematic view of the experimental setup is shown in Fig. 6. The Sn atoms were excited by a third harmonics, narrow-band Ti:sapphire laser tuned to the 5p² 3P₂ - 6s 3P₀ (286.3 nm) transition line of atomic tin. The fluorescence from the 5p² 3P₂ - 6s 3P₀ (317.5 nm) transition was observed through a band-pass filter with an image-intensified CCD (ICCD) camera. Two-dimensional atom distributions were obtained using a thin, sheet-like laser beam that probed a plane parallel to the direction of laser irradiation (plane normal was perpendicular to the axis of the laser beam).

The amount and the distribution of Sn neutral atoms after the pre-pulse laser irradiation in a magnetic field of certain strength were observed experimentally. Fig. 7 shows one example result of the LIF measurements. After an irradiation by a CO₂ laser of insufficient energy, the neutral atoms and the fragments manifested themselves by a strong fluorescence (blue light on image). In contrast, no neutral atoms and fragments were observed after CO₂ laser irradiation with high enough energy.

The ionization ratio can be calculated by spatial integration of the fluorescence signals. The calculated ionization ratio vs. CO₂ laser energy is shown in Fig.8 and CE vs. CO₂ laser energy is shown in Fig.9, having the pre-pulse duration as a parameter in both.
shown in Fig. 8. This data indicates that a high ionization ratio can be obtained when CO₂ laser energy is in excess of 100-200mJ. In contrast, the ionization ratio was near-unity even with the CO₂ pulse energy below 20mJ in the case of 10 ps pre-pulse. It is good news, because a lower power, 20kW CO₂ laser seems sufficient to achieve the planned 250W EUV power level. The debris mitigation system may also work better in the situation of lower power operation.

2.3 Droplet generator & magnetic-mitigation technology

The tin injected into the active region has to be almost fully captured in order to mitigate the detrimental effects the deposition and erosion by energetic ions have on the collector mirror lifetime. Our idea of magnetic-field-assisted technique of Sn debris mitigation is simple. A strong magnetic field traps the Sn ions and electrons that remain after the process of EUV emission from Sn plasma. The maximization of the ionization ratio is therefore essentially important not only for the conversion efficiency, but also for an effective management of Sn debris. In a perfect case of all the Sn atoms becoming ionized, all debris could possibly be guided along the magnetic flux. Also, some neutral atoms could be trapped and guided following a charge exchange with the ions.\(^\text{11)}\)

In reality, however, not all the Sn atoms and ions can be effectively trapped in the magnetic field. In order to accommodate for that real-life problem, our system is also equipped with a chemical etching mechanism. With this mechanism the “rogue” Sn atoms and clusters, which have managed to deposit on EUV collector optics, viewports, chamber walls and other internal equipment, can be removed (Fig. 10).\(^\text{12)}\)

Numerous optimization studies have been carried out to determine the optimum performance of debris mitigation technique to match the operational conditions of a production EUV source. The beneficial combination of 20μm droplets and 10ps pre-pulse irradiation, leading to a near-100% ionization ratio, has been implemented in our 100kHz prototype system.

2.3.1 20 μm diameter droplet generator

A generation of a sufficiently small Sn droplet is particularly important in the process of Sn debris mitigation, because the amount of Sn should be minimized to what is absolutely necessary to obtain enough EUV photons without compromising the overall performance of a droplet generator. Recently we have succeeded to realize a stable generation of 20μm diameter droplets. The performance of our 20μm droplet generator is shown in Fig. 11.
2.3.2 Debris dependency on droplet size

A deposition of Sn layer only 1 nm thick (a few atomic layers) degrades the mirror reflectivity by 10%, which has to be taken into consideration in the mirror lifetime specification. A study aiming to determine a relationship between an amount and a character of the laser-produced debris and the droplet diameter was carried out. Several droplet diameters were used and a deposition rate in several locations on a dummy collector mirror was measured, as shown in Fig. 12. Table 1 shows the results obtained at the A1 position. The deposition rate in case of the 20μm droplet, which contained nearly half the mass as compared to the 25μm droplet, was found to be five times smaller and around 0.1nm per million pulses. During these experiments, however, an accuracy of laser targeting system was still an issue and, as a consequence, a fragment-type debris was observed and a standard deviation of recorded EUV energy was large, especially in the case of the smaller 20μm droplet. A problem of an insufficient control of the irradiation condition still remains to be solved.

Table 1. Comparison of recorded deposition rates.

<table>
<thead>
<tr>
<th></th>
<th>25μm Droplet</th>
<th>20μm Droplet</th>
</tr>
</thead>
<tbody>
<tr>
<td>Pulse number</td>
<td>152 x 10^9 pl</td>
<td>80 x 10^9 pl</td>
</tr>
<tr>
<td>H₂ pressure</td>
<td>15 Pa</td>
<td>15 Pa</td>
</tr>
<tr>
<td>EUV Energy (3σ)</td>
<td>23.3%</td>
<td>73.4%</td>
</tr>
<tr>
<td>A1 sample Center</td>
<td>23.3%</td>
<td>73.4%</td>
</tr>
<tr>
<td>Sn deposition rate</td>
<td>0.5 nm/ x 10^9 pl</td>
<td>0.1 nm/ x 10^9 pl</td>
</tr>
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2.4 IR reduction technology on collector mirror

The EUV light emitted by the plasma is collected by a multilayer mirror. Beside the EUV, the plasma emits also the accompanying thermal radiation and also reflects a significant fraction of the CO₂ laser light. These undesired, out-of-band components are strongly reflected by the collector mirror, as shown in Fig. 13.

In the past, several kinds of transmission filters were used to cut the out-of-band light. However, the performance of a transmission filter was limited by an optical absorption of the filter material itself, giving rise to heat management problems. We have devised a new type of filter, which has a diffractive, grating-like structure fabricated on the surface of the multilayer coating (patent pending). Fig. 14 shows schematically the principle of operation of this new filter. The IR light reflected from the multilayer coating creates an interference pattern at a focal plane such that the IR light can be absorbed by an aperture stop while the shorter wavelengths can pass with a low loss. A drawback of this kind of solution is a reduction of reflectivity of the collector mirror in the EUV band. Fig. 15 shows the results of EUV reflectivity measurements of a collector mirror featuring the IR-rejection filter. The data show that the reduction of EUV reflectivity was not critical and only around 4% throughout the whole of the collector mirror surface.

Fig. 13. Typical reflectivity of the multi-layer EUV collector mirror.

Fig. 14. Schematic of a test setup used to evaluate the performance of new type, diffractive IR filter.

Fig. 15. Measurement result of EUV reflectivity as a function of radial position on the collector mirror featuring the IR rejection filter (green line with circles).

Fig. 16 presents an experimental confirmation of the filter operation, obtained in the test setup measurement depicted in Fig. 14. A significant reduction of the IR light by more than 99% was recorded, which was an excellent result.

Fig. 16.
2.5 EUV light source system

The first generation of our projected HVM EUV light source comprises of 100 kHz rep-rate, 20 kW CO2 laser, the 20μm droplet generator and the magnetic field debris mitigation. An overview of the light source is shown in Fig 17.

The EUV chamber vessel contains the droplet generator, the collector mirror, and several vacuum pumps. The main function of the EUV chamber vessel is to maintain high level vacuum environment around the EUV-emitting plasma and to facilitate and implement the extraction of plasma remnants and Sn debris in order to maximize the performance and lifetime of the EUV collector mirror. In order to implement the Sn debris mitigation, a pair of superconducting, magnetic coils is arranged on two opposite sides of the vessel.

The EUV chamber should be located closely next to a scanner in order to minimize the loss of EUV power. The clean room floor of the EUV exposure tool is mainly occupied by the scanner, therefore the CO2 laser system is located on a different floor than the scanner (usually below) to minimize the overall footprint in the clean room area.

3. System Test and Result

3.1 Prototype systems

We have constructed two prototype EUV source systems so far, called “proto #1” and “proto #2”. The configuration and specification data of both systems are shown in Table 2, along with the data describing the production system under development (“customer beta”). A major difference between the three systems is the CO2 laser power and the output angle of EUV beam line, while other specifications are essentially the same.

A construction of “proto #1” system was commenced in 2011. A suitable system technology had been developed since then and an extensive testing of the building blocks was undertaken. We have achieved 34W clean EUV power (I/F) using the “proto #1” system. There were two major issues however, one was a necessity to improve the long-term stability of the droplet generator, and the other was a need for more CO2 laser power.

3.2 Latest experimental result of Proto #2 system

The knowledge gained during the development period of “proto #1” system enabled us to undertake a construction of an upgraded “proto #2” system. It was initiated in a second half of 2013 and the system became operational in the beginning of 2014. Substantial progress has been made since then. The stability of the droplet generator was improved dramatically and the CO2 laser power at target was raised from 5 kW to 8 kW.
as to assure the mechanical compatibility with the EUV exposure tool while at the same time to provide an easy access to all components for the maintenance purposes.

The first experimental result of Proto #2 is shown in Fig.19 (a) and (b). 16.9W of clean EUV was recorded at the intermediate focus point (IF) in burst mode of operation characterized by 20 kHz repetition rate of EUV pulses and 50% burst duty cycle (ON/OFF = 0.5 sec / 0.5 sec ). CE was measured to be 3.9%. Also, 43.4W clean EUV power was recorded at 100kHz repetition rate of EUV pulses and 50 % burst duty cycle (ON/OFF = 0.1 sec / 0.1 sec). In this case the CE of 2.4% was obtained. The substantial difference of CE values between these two modes of operation is under investigation at present.

Fig.19  EUV emission data at (a) conversion efficiency of 3.9% and EUV clean power of 16.9W, and (b) conversion efficiency of 2.4% and EUV clean power of 43.4W.

3.3 Scale-up plan for CO2 laser power

The achievement of higher CE values must be accompanied by further improvement of available CO2 laser drive power in order to reach our EUV power target of 250W. For that purpose a 20kW master-oscillator-power-amplifier (MOPA) laser system is required.

The master oscillator (OSC) is an original, solid-state seeded, multi-pass amplifier custom-built around a small, slab-waveguide, RF-excited CO2 laser. It is characterized by a multi-line operation intended for an enhanced energy extraction in the power amplifiers. The seed pulses are generated independently by a set of four solid-state, quantum-cascade lasers (QCL) allowing for an asynchronous, on-demand generation of highly stable pulses of a width adjustable electronically from about 12 to 40 ns, and with repetition rates from practically 0 to 100 kHz.

The output from the master oscillator is pre-amplified to about 150W by a system of custom-design, multi-pass, small slab-waveguide, amplifiers (Osc-AMP). Subsequently, the pre-amplifier (Pre-AMP), which is custom-built on a largest available slab-waveguide laser, boosts the power to a level of 2kW (20mJ at 100kHz). The following two or three main-amplifiers (main-AMP) amplify the pulse emerging from the PreAMP to a final 5kW and 8kW at the target location, in “proto #1” and “proto #2” systems respectively. The MOPA laser system is operable from low duty mode (2 %) to full duty mode (100 %).

Fig. 20. Scale-up plan for the driver CO2 laser power.

Since 2011 we have had a support of New Energy and Industrial Technology Development Organization (NEDO) to aid our development of a new CO2 amplifier in cooperation with Mitsubishi Electric. As a result of this successful effort, new Pre-AMP and main-AMP designs emerged, enabling us to make a further improvement of the CO2 laser power. “Proto #2” is currently undergoing an upgrade of the Pre-AMP to a new type capable of 4-5kW output (40-50mJ at 100kHz) leading to a projected 14kW power at plasma point. Fig.21 shows a picture of this new pre-amplifier taken during installation activities in our laboratory.

Fig. 21. Installation of new pre-amplifier in the “proto #2” CO2 laser system.
A development work on a new power amplifier system aiming at the 20kW CO2 laser power level at plasma is ongoing in co-operation with Mitsubishi. In 2013 we succeeded to demonstrate 21 kW output power with an engineering prototype (equivalent to “Pilot #1” in Fig.20) consisting entirely of Mitsubishi-developed, fast-transverse-flow, RF-discharge excited laser units\(^{15,16,18}\).

4. Conclusions

We have reported on a progress of component technology of EUV light source system. 20\(\mu\)m droplets at 100 kHz emission rate were successfully generated and a dramatic reduction of debris deposition rate on the collector mirror was demonstrated. An IR rejection technology was incorporated into the collector mirror by the maker and shown to be capable of very effective >99% reduction of undesired IR radiation. We have demonstrated a successful generation of EUV in our “proto #2” system and also 200W EUV power at plasma and 43W clean EUV power at the intermediate focus plane at 100kHz pulse repetition frequency. High conversion efficiency (CE) of 3.9 % (at 20 kHz) was confirmed using the pico-second pre-pulse. A further improvement of “proto #2” CO2 laser power (from 8kW to 12 kW at plasma point) is expected to follow the installation of the new pre-amplifier. Next target is a week-level source operation delivering 100W clean EUV power with CE=3.5 % and 12 kW CO2 laser power.

New >20 kW CO2 laser power amplifier system is under construction in co-operation with Mitsubishi Electric Corporation. The milestone of this development branch is shown in Table 2 as a “customer beta” system. We are planning to achieve EUV power generation with CE=4.5% using 20kW CO2 laser power by the end of Q2 of 2015. Final target is a week-level operation producing a clean 250W EUV power at the intermediate focus. Target shipment date of our first “customer beta” LPP light source unit is projected for 2015.

5. Acknowledgement

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Authors were very sad to learn of a sudden and premature death of Dr. Yoichi Tanino on 1st February in 2014. We appreciate his extremely great job of CO2 amplifier development in a very short period of time and pray for his soul.

6. References

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